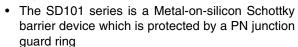


**Vishay Semiconductors** 

# **Small Signal Schottky Diodes**

#### **Features**

- For general purpose applications
- The low forward voltage drop and fast switching make it ideal for protection of MOS devices, steering, biasing and coupling diodes for fast switching and low logic level applications



- These diodes are also available in the Mini-MELF case with type designations LL101A to LL101C, in the DO35 case with type designations SD101A to SD101C and in the SOD323 case with type designations SD101AWS-V to SD101CWS-V
- · Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



#### **Mechanical Data**

Case: SOD123 Plastic case Weight: approx. 10.3 mg

#### Packaging Codes/Options:

GS18/10 k per 13" reel (8 mm tape), 10 k/box GS08/3 k per 7" reel (8 mm tape), 15 k/box

#### **Parts Table**

Part	Ordering code	Type Marking	Remarks
SD101AW-V	SD101AW-V-GS18 or SD101AW-V-GS08	SA	Tape and Reel
SD101BW-V	SD101BW-V-GS18 or SD101BW-V-GS08	SB	Tape and Reel
SD101CW-V	SD101CW-V-GS18 or SD101CW-V-GS08	SC	Tape and Reel

## **Absolute Maximum Ratings**

T<sub>amb</sub> = 25 °C, unless otherwise specified

Parameter	Test condition	Part	Symbol	Value	Unit
Peak reverse voltage		SD101AW-V	$V_{RRM}$	60	V
		SD101BW-V	$V_{RRM}$	50	V
		SD101CW-V	$V_{RRM}$	40	V
Power dissipation (Infinite heatsink)			P <sub>tot</sub>	400 <sup>1)</sup>	mW
Forward continuous current			I <sub>F</sub>	30	mA
Maximum single cycle surge	10 μs square wave		I <sub>FSM</sub>	2	Α

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#### **Thermal Characteristics**

T<sub>amb</sub> = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit	
Thermal resistance junction to ambient air		$R_{thJA}$	300 <sup>1)</sup>	K/W	
Junction temperature		T <sub>j</sub>	125 <sup>1)</sup>	°C	
Storage temperature range		T <sub>stg</sub>	- 65 to + 150	°C	

<sup>1)</sup> Valid provided that electrodes are kept at ambient temperature

## **Electrical Characteristics**

T<sub>amb</sub> = 25 °C, unless otherwise specified

Parameter	Test condition	Part	Symbol	Min	Тур.	Max	Unit
Reverse breakdown voltage	I <sub>R</sub> = 10 μA	SD101AW-V	V <sub>(BR)</sub>	60			V
		SD101BW-V	V <sub>(BR)</sub>	50			V
		SD101CW-V	V <sub>(BR)</sub>	40			V
Leakage current	V <sub>R</sub> = 50 V	SD101AW-V	I <sub>R</sub>			200	nA
	V <sub>R</sub> = 40 V	SD101BW-V	I <sub>R</sub>			200	nA
	V <sub>R</sub> = 30 V	SD101CW-V	I <sub>R</sub>			200	nA
Forward voltage drop	I <sub>F</sub> = 1 mA	SD101AW-V	V <sub>F</sub>			410	mV
		SD101BW-V	$V_{F}$			400	mV
		SD101CW-V	$V_{F}$			390	mV
	I <sub>F</sub> = 15 mA	SD101AW-V	$V_{F}$			1000	mV
		SD101BW-V	V <sub>F</sub>			950	mV
		SD101CW-V	V <sub>F</sub>			900	mV
Diode capacitance	V <sub>R</sub> = 0 V, f = 1 MHz	SD101AW-V	C <sub>D</sub>			2.0	pF
		SD101BW-V	C <sub>D</sub>			2.1	pF
		SD101CW-V	C <sub>D</sub>			2.2	pF
Reverse recovery time	$I_F = I_R = 5 \text{ mA},$		t <sub>rr</sub>			1	
	recover to 0.1 I <sub>R</sub>						

## **Typical Characteristics**

 $T_{amb}$  = 25 °C, unless otherwise specified

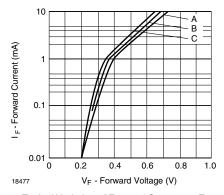


Figure 1. Typical Variation of Forward Current vs. Forward Voltage

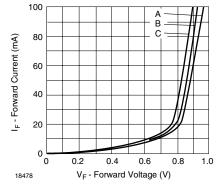


Figure 2. Typical Forward Conduction Curve



## **Vishay Semiconductors**

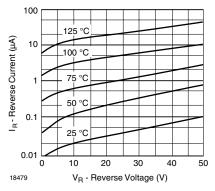


Figure 3. Typical Variation of Reverse Current at Various Temperatures

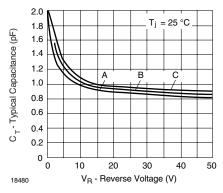
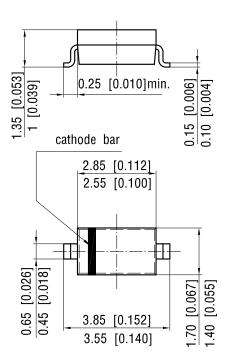
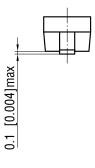


Figure 4. Typical Capacitance Curve as a Function of Reverse Voltage

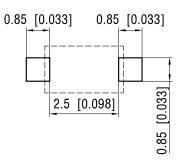
## Package Dimensions in mm (Inches): SOD123



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### **Vishay Semiconductors**



#### **Ozone Depleting Substances Policy Statement**

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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